

No. 10-01-03-01/01

SYSTEM: Space Shuttle RSRM 10 CRITICALITY CATEGORY: SUBSYSTEM: Case Subsystem 10-01 PART NAME: Systems Tunnel Floor ASSEMBLY: Case 10-01-01 Plate Assembly (1) FMEA ITEM NO.: 10-01-03-01 Rev M PART NO.: (See Section 6.0) CIL REV NO.: PHASE(S): Boost (BT) М DATE: 17 Jun 2002 QUANTITY: (See Section 6.0) SUPERSEDES PAGE: 220-1ff. EFFECTIVITY: (See Table 101-6) 31 Jul 2000 HAZARD REF.: BC-11 DATED: CIL ANALYST: D. F. Bartelt APPROVED BY: DATE: RELIABILITY ENGINEERING: K. G. Sanofsky 17 Jun 2002 P. M. McCluskey **ENGINEERING:** 17 Jun 2002 1.0 FAILURE CONDITION: Failure during operation (D) 2.0 FAILURE MODE: 1.0 Structural failure 3.0 FAILURE EFFECTS: Loss of range safety device and TVC. Debris damage to the External Tank and Orbiter would cause the loss of SRB, crew, and vehicle 4.0 FAILURE CAUSES (FC): FC NO. DESCRIPTION FAILURE CAUSE KEY 1.1 Acoustic vibration and aeroshear Α 1.2 Failure of EPDM rubber 1.2.1 Nonconforming physical properties В 1.2.2 С Age degradation 1.2.3 Moisture or fungus degradation D 1.3 Failure of the EPDM-to-case bond 1.3.1 Bonding surfaces not properly prepared or adequately cleaned Ε 1.3.2 Bonding material not properly mixed, applied, or cured F 1.3.3 Contamination during processing G 1.3.4 Process environments detrimental to bond strength 1.3.5 Nonconforming adhesive material properties 1.3.6 Bond strength degradation during storage, handling, or transportation 1.3.7 Improper adhesive thickness Κ 1.4 Failure of the EPDM-to-floor plate vulcanization bond 1.4.1 Nonconforming bond enhancement material L

REVISION M DOC NO. TWR-15712 VOL II

SEC 220 PAGE 1



DATE: 17 Jun 2002
No. 10-01-03-01/01 SUPERSEDES PAGE: 220-1ff.
DATED: 31 Jul 2000

1.4.2 Bonding surfaces not adequately cleaned

M

1.4.3 Bonding enhancement material not properly mixed, applied, or cured

Ν

#### 5.0 REDUNDANCY SCREENS:

SCREEN A: N/A SCREEN B: N/A SCREEN C: N/A

### 6.0 ITEM DESCRIPTION:

1. Assembly of the systems tunnel floor plate to the case (Figures 1 and 2) is accomplished per engineering drawings. Materials are listed in Table 1.

Table 1. MATERIALS

Drawing No.	Name	Material	Specification	Quantity
1U82856	Floor Plate Assembly	Various		34/motor
(various)	Case Segments	D6AC Steel	STW7-2744	11/motor
(various)	Tunnel Floor Plate	Aluminum Alloy 2219-T87	QQ-A-250/30	34
,	Thermal Insulation	Silica-Filled EPDM Rubber	STW4-2736	195 lb
	Adhesive Paste & Curing Agent	Epoxy Resin EA934NA	STW4-3218	A/R
	Rubber-to-Metal Primer	Adhesive Primer	STW5-2664	6.4 lb
	High Temp Primer	Adhesive Primer	STW5-3215	A/R
	Rubber-to-Metal Adhesive	Adhesive	STW5-2798	8.5 lb
1U82854	Tunnel Splice Plate Assembly	Aluminum Alloy 2219-T87	QQ-A-250/30	6
1U77610	Segment, Rocket Motor, Forward	Various		1/motor
1U77620	Segment, Rocket Motor, Fwd/Center	Various		1/motor
1U77630	Segment, Rocket Motor, Aft/Center	Various		1/motor
1U77640	Segment, Rocket Motor, Aft	Various		1/motor

### 6.1 CHARACTERISTICS:

 EPDM rubber is vulcanized to the floor plate assembly that is bonded to the steel case. The floor plate assembly protects and holds instrumentation cables, Linear-Shaped Charge (LSC), and other ordnance lines.

### 7.0 FAILURE HISTORY/RELATED EXPERIENCE:

 Current data on test failures, flight failures, unexplained failures, and other failures during RSRM ground processing activity can be found in the PRACA Database.

# 8.0 OPERATIONAL USE:

N/A

REVISION M DOC NO. TWR-15712 VOL II



No. 10-01-03-01/01

DATE: 17 Jun 2002 SUPERSEDES PAGE: 220-1ff. DATED: 31 Jul 2000

## Floor Plate Assembly

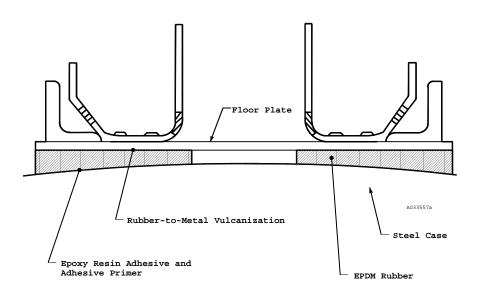


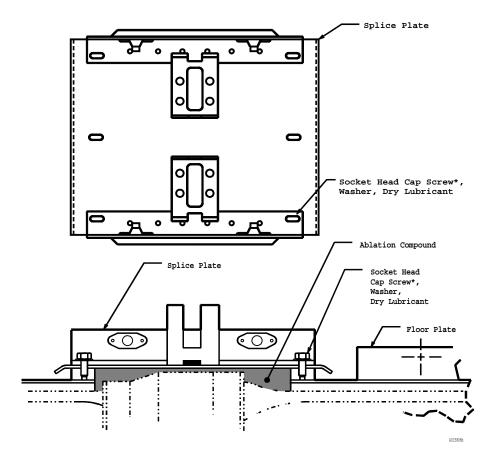
Figure 1. Tunnel Floor Plate Assembly

REVISION M 5EC 220 PAGE 3



No. 10-01-03-01/01

DATE: 17 Jun 2002 SUPERSEDES PAGE: 220-1ff. DATED: 31 Jul 2000



<sup>\*</sup>Socket head cap screw on forward segment and 2 center segments at field joints. Hex head cap screws only on aft segment

Figure 2. Tunnel Splice Plate Joint Section

REVISION  $\underline{\mathbf{M}}$  DOC NO. TWR-15712  $V_{\text{VOL}}$  II SEC 220 PAGE 4



DATE: 17 Jun 2002 No. 10-01-03-01/01 SUPERSEDES PAGE: 220-1ff. DATED: 31 Jul 2000

## 9.0 RATIONALE FOR RETENTION:

# 9.1 DESIGN:

# DCN FAILURE CAUSES

<u>JIN</u>	FAILURE CAUSES		
	Α	1.	A stress analysis of the systems tunnel bond lines for ascent loading, including aerodynamic and acoustic loads, was performed. This analysis showed positive margins of safety for the EPDM-to-case bond and the EPDM-to-tunnel bond per TWR-13694.
	В	2.	Physical properties of cured and uncured EPDM rubber are defined per engineering.
	В	3.	The formula for EPDM rubber to ensure proper physical properties is defined per engineering.
	В	4.	EPDM material properties and stress and strain values for the systems tunnel application were determined and reported in TWR-12856.
	С	5.	Age control requirements of EPDM material specifications limit the times allowed for mixing-to-shipment, shipment, storage, lay up-to-cure, and also specific temperature requirements.
	D,E,G,H	6.	Paint is removed to bare metal at floor plate pad bonding locations on the case. The clean, bare metal surface is completely covered with adhesive primer, and the primer is ambient dried.
	D,E,G,H	7.	Control of workmanship assures that epoxy resin adhesive and adhesive primer will be free from agglomeration, foreign matter, separation, dilution, and contamination.
	D,E,G,H	8.	EPDM will be free from surface contamination such as grease, oil, foreign materials, or other contaminants.
	D,E,G,H	9.	The factor of safety for the systems tunnel bond line for ascent is 2.0. An analysis was performed and showed a positive margin of safety per TWR-13694.
	D,E,G,H	10.	A fungus certification test was performed to ensure that materials used to attach the aluminum systems tunnel to the steel RSRM do not support fungal growth per TWR-16851.
	D,E,G,H	11.	EPDM for the systems tunnel is accepted for use per a material use agreement.
	F,I,K	12.	Adhesive primer and epoxy resin adhesive are mixed, applied, and cured per engineering drawings and specifications.
	F,J,K	13.	Epoxy adhesive resin has a minimum tensile strength as defined per engineering.
	F,K	14.	Thickness of the adhesive is controlled per engineering drawings and waviness of the case. Thickness of the adhesive is determined during application by the application tool, and therefore, improper thickness would only result from improper application.
	F,K	15.	A test was performed with a similar adhesive using a 0.25-thick coating compared to a thin coating. Analysis showed no strength problem per TWR-15173.
	F,K,L,M,N	16.	Contamination control requirements and procedures are described in TWR-16564.

REVISION M 5EC 220 PAGE 5



		No. 10-01-03-01/01	DATE: SUPERSEDES PAGE: DATED:	17 Jun 2002 220-1ff. 31 Jul 2000
1	17.	Epoxy resin adhesive is a two-part epoxy (part powder-filled, thixotropic epoxy resin in paste form, amine-type liquid curing agent.	A) consisting of graand (part B) consisti	ay aluminum ng of amber,
I	18.	Epoxy resin adhesive and adhesive primer med criteria are established per TWR-18011.	hanical properties a	nd selection
1	19.	Epoxy resin adhesive and primer system material 16671 and TWR-17735.	properties are certifie	ed per TWR-
l,J	20.	Adhesive primer (Silane) has a controlled storage required per engineering. Packaging of the prim containers.		
F,G,K	21.	Epoxy resin adhesive storage life is per engineering		
J	22.	Loads induced as a result of transportation and har the structural integrity of RSRM loaded segment co all components within the loaded segments we transportation and handling prior to flight per TWR-1	mponents. It was def vere structurally so	termined that
J	23.	Rail car transportation shock and vibration levels for engineering and loads are derived per analysis. M Thiokol to verify that shock and vibration levels define not exceeded.	onitoring records are	evaluated by
J	24.	Thermal analyses were performed for RSRI transportation and storage to determine accept environment exposure limits per TWR-50083. exposure to the ambient environment during in-picontrolled per in-plant transportation and environment.	table temperature a Component temperation or	and ambient eratures and
J	25.	TEM motor floor plate pull tests were used to dem Bond meets "useful life" requirements and demonst epoxy resin adhesive per TWR-64178.		
L,N	26.	Adhesive primers and bonding agents are mixed corrosion protection and insulation bonding per engi		
L	27.	Vulcanized metal adhesive and primer system mate TWR-16671.	erial properties are es	tablished per
L,N	28.	Rubber-to-metal adhesive is applied over primer per	engineering and sho	p planning.
M,N	29.	Cleaning of bonding surfaces is controlled per shop	planning.	
N	30.	EPDM is cured (vulcanized) to the floor plate w rubber-to-metal primer at controlled elevated controlled timing per shop planning.		
A,B,C,E,G,H, I,J,K,L,M,N	31.	TWR-66825-2 and -6 were updated to incorporate (PE) Program. Predicted PE temperatures and action Tunnel, Systems Tunnel Cork, and GEI TPS remfactors were updated to include rigid body loinsignificant. Existing stresses and structural margin Aero/Heating Certification are valid for PE per TWR	erodynamic loads for ain essentially uncha ads, but resulting ns of safety quoted fo	the Systems inged. Load effects were

REVISION M 5EC 220 PAGE 6



No. 10-01-03-01/01

DATE:

DATED:

SUPERSEDES PAGE:

17 Jun 2002

31 Jul 2000

220-1ff.

TEST AND INSPECTION 9.2 FAILURE CAUSES and DCN TESTS (T) **CIL CODE** For New Thermal Insulation, EPDM, Silica-Filled, verify: В (T) Specific gravity ALT017,ALT020 a. В (T) b. Tensile strength ALT027,ALT031 В (T) C. Ultimate elongation ALT041,ALT042 В ALT005, ALT006 (T) d. Hardness 2. For Retest, Thermal Insulation, EPDM, Silica-Filled, verify: С (T) Tensile strength ALT034 a. С (T)b. Ultimate elongation ALT045 С (T)C. Hardness ALT009 3. For the New Floor Plate Assembly verify: M.N AHI010 a. Floor plate bonding surface was properly grit blasted and is clean 585 Floor plate bonding surface is cleaned with approved solvent prior M.N b. to applying primer and adhesive AHI005 M,N C. Application of primer **AHI001** M,N Application of adhesive AHI000 d. M,NInsulation working area, table cutting surface, and cutting utensils e. are cleaned prior to cutting insulation, and gloves are worn during cutting operation AHI006 M,Nf. Gloves are worn during lay up operation **AHI007** M,N Bonding surface is protected to prevent surface contamination, g. after adhesive is applied and prior to vulcanization AHI013 h. Floor plate assembly is wrapped with protective packing and tape AHI016 M,N B,N Cure process AHI014 i. Shelf life of uncured EPDM rubber ALT010 С k. Ν Edge unbonds, if any, due to normal processing are within AHI012 drawing requirements. For New Segment, Rocket Motor (Forward, Forward Center, Aft Center, and Aft), verify: D,E,G,H Floor plate bonding surfaces are cleaned prior to a. installation AET018,AEU017,AGA017,AEW018 D.E.G.H b. Paint removal for floor plate installation AET023,AEU022,AGA022,AEW023 D,E,G,H Floor plate bonding surface of case is cleaned C. AET003,AEU003,AGA003,AEW003 prior to bonding B,C,D,E, F,G,H,I,J, K,L,M,NFloor plate pull tests are acceptable AET020,AEU019,AGA019,AEW020 (T) d. D,E,F,G, H.I.K (T) Floor plate witness panel results are acceptable e. for adhesive primer, silane, and epoxy resin adhesive RAA233,RAA234,RAA235,RAA236 F,K f. Adhesive primer (silane) for floor plate bonding is properly applied AET000,AEU000,AGA000,AEW000 F,K Adhesive primer (silane) for floor plate bonding is properly dried AET001,AEU001,AGA001,AEW001 F.K h. Epoxy resin adhesive for floor plate bonding is AET015,AEU014,AGA014,AEW015 properly mixed F,K i. Epoxy resin adhesive for floor plate bonding is



			No. 10-01-03-01/01	DATE: SUPERSEDES PAGE: DATED:	17 Jun 2002 220-1ff. 31 Jul 2000
F,K J	(T)		<ul> <li>j. Epoxy resin adhesive for floor plate bonding is cured to time and shore D requirements A</li> <li>k. Component environments during in-plant</li> </ul>	ET013,AEU012,AGA0 ET014,AEU013,AGA0 BAA021,BAA022,BAA	013,AEW014
		5.	For New Primer, Adhesive - Silane verify:		
D,E,G,H,I D,E,G,H,I I I F,K	(T) (T) (T)		<ul> <li>a. Workmanship</li> <li>b. Color</li> <li>c. Infrared identification</li> <li>d. Bond strength and durability</li> <li>e. Acidity</li> <li>f. Adhesive primer is properly mixed</li> </ul>		ANY013 POG001 ANY022 ANY000 ANY001 AET002
		6.	For New Adhesive Primer, verify:		
L L L L	(T) (T) (T) (T)		<ul><li>a. Solids content</li><li>b. Density</li><li>c. Viscosity</li><li>d. Peel adhesion</li><li>e. Workmanship</li></ul>	AMR( AMR)	059,AMR067 006,AMR012 083,AMR092 026,AMR022 AMR041
		7.	For New Adhesive, Rubber-to-Metal verify:		
L L L L	(T) (T) (T) (T)		<ul> <li>a. Solids content</li> <li>b. Specific gravity</li> <li>c. Viscosity</li> <li>d. Peel strength, rubber-to-steel</li> <li>e. Workmanship</li> </ul>	AND AND	028,AND026 033,AND036 046,AND044 014,AND009 FAA842
		8.	For New Epoxy Resin Adhesive, Non-Asbestos verify:		
                 	(T) (T) (T) (T)		<ul> <li>a. Filler content (Part A)</li> <li>b. Epoxide content (Part A)</li> <li>c. Titratable nitrogen (Part B)</li> <li>d. Certificate of Conformance</li> <li>e. Workmanship</li> <li>f. Working life</li> <li>g. Tensile adhesion steel-to-steel</li> </ul>	AMD	009,AMD013 002,AMD006 035,AMD039 FAA014 AMD015 AMD043 AMD031
		9.	For Retest Epoxy Resin Adhesive, Non-Asbestos, verify		
I	(T)		a. Tensile adhesion steel-to-steel		AMD033

REVISION M DOC NO. TWR-15712 VOL II